

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
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Assignment ID: PATI306147

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
ADVANCED MATERIAL TECHNOLOGIES, INC.	02/14/2024
<b>RECEIVING PARTY DATA</b>	
<b>Company Name:</b>	I-PEX Piezo Solutions Inc.
<b>Street Address:</b>	2-1-17 Asutopia, Ube-shi
<b>City:</b>	Yamaguchi
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	755-0152
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Patent Number:	9903898
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	2027218250
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<b>ATTORNEY DOCKET NUMBER:</b>	2014-1660A
<b>NAME OF SUBMITTER:</b>	Reona Nomura
<b>SIGNATURE:</b>	Reona Nomura
<b>DATE SIGNED:</b>	06/20/2024
<b>Total Attachments: 2</b>	
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source=Assignment-1660A#page2.tif	

## **ASSIGNMENT**

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

ASSIGNOR: ADVANCED MATERIAL TECHNOLOGIES, INC.  
(Name of ASSIGNOR)

1-12-22 Tsukiji, Chuo-ku, Tokyo, Japan  
Address

having been assigned its right, title and interest in the invention by virtue of an Assignment recorded at the U.S. Patent and Trademark Office on June 29, 2018 at Reel 046463, Frame 0924, hereby sells, assigns and transfers to

ASSIGNEE: I-PEX Piezo Solutions Inc.  
(Name of ASSIGNEE)

2-1-17 Asutopia, Ube-shi, Yamaguchi, 755-0152 Japan  
Address

and the successors, assigns and legal representatives of the ASSIGNEE

(X) the entire right, title and interest

() a partial interest

in the invention entitled:

**THERMAL POLING METHOD, PIEZOELECTRIC FILM AND MANUFACTURING  
METHOD OF SAME, THERMAL POLING APPARATUS, AND INSPECTION METHOD  
OF PIEZOELECTRIC PROPERTY**


and which is found in U.S. patent no. 9,903,898 issued February 27, 2018

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to

ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purpose thereof.

IN WITNESS WHEREOF, I/WE have hereunto set hand and seal this February 14 2024.  
(Date of Signing)

  
(Signature of person authorized to sign on behalf of ASSIGNOR)

Shosuke KIBA  
(type or print the name of person who signs above)

President & CEO  
(Official Title of person who signs above)

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The above application may be more particularly identified as follows:

U.S. Patent Application No. 14/578,907 Filing Date: December 22, 2014

Applicant Reference Number FP1246US Atty Docket No. 2014-1660A

Title of Invention: THERMAL POLING METHOD, PIEZOELECTRIC FILM AND  
MANUFACTURING METHOD OF SAME, THERMAL POLING APPARATUS, AND INSPECTION  
METHOD OF PIEZOELECTRIC PROPERTY